

EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|-------|---------|---|---|------------------|---------|------------------|
| L2 | 2 | ("6266249").PN. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 18:04 |
| S1 | 608897 | (substrate board PCB) with (groove opening recess hole via passage) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/02/21 03:18 |
| S2 | 1505283 | (pattern conductor trace (conductive line)) with (groove opening recess hole via passage) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/02/21 03:19 |
| S3 | 9526 | conductive adj (groove opening recess hole via passage) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2006/02/21 03:19 |
| S4 | 5983 | S1 and S2 and S3 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:20 |
| S5 | 338166 | "257"/\$.ccls. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:21 |
| S6 | 2730 | S4 and S5 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:21 |
| S7 | 137 | S6 and (laser near3 cut\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:22 |

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| S8 | 278 | S6 and ((laser near3 cut\$4) or (tape-casting (doctor blade))) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:22 |
| S9 | 189 | S8 and etch\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:23 |
| S10 | 100 | S9 and sputter\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:24 |
| S11 | 60 | S8 and (chemical near2 etch\$4) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:24 |
| S12 | 45 | S11 and sputter\$4 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 03:24 |
| S13 | 12 | @ad <= "20000601" and S12 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:44 |
| S14 | 17 | "5986338" | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 12:07 |
| S15 | 2 | ("5986338").PN. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:42 |

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| S16 | 0 | substrate with (conductive adj vias) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:43 |
| S17 | 1671 | substrate with (conductive adj vias) | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:43 |
| S18 | 2740 | 257/778.ccls. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:44 |
| S19 | 83 | S17 and S18 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:44 |
| S20 | 32 | @ad <= "20000601" and S19 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:52 |
| S21 | 806 | 361/761.ccls. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:52 |
| S22 | 12 | S21 and S17 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:52 |
| S23 | 7 | @ad <= "20000601" and S22 | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 16:53 |

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| S24 | 2 | ("6845184").PN. | US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2006/02/21 18:03 |
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